



SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary (@TA = +25°C)

V _{RM} (V)	I _O (mA)	V _{F(MAX)} (V)	I _{R(MAX)} (μA)
40	30	0.37	0.5

Features and Benefits

- Low Forward Voltage Drop
- Guard Ring Die Construction for Transient Protection
- Ideal for low logic level Applications
- Low Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Applications

- SMPS
- DC-DC Converter
- Freewheeling Diodes
- Reverse Polarity Protection
- Blocking Diodes

Mechanical Data

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe.
 Solderable per MIL-STD-202, Method 208 <a>3
- Weight: 0.002 grams (Approximate)

SOD523



Top View

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
SDM03U40Q-7	Automotive	SOD523	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SOD523



LK = Product Type Marking Code

SDM03U40Q Document number: DS38986 Rev. 5 - 2



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Reverse Voltage	V _{RM}	40	V
DC Reverse Voltage	V _R	30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Rectified Current	Io	30	mA
Non-Repetitive Peak Forward Surge Current @8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	200	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient (Note 6) Thermal Resistance, Junction to Ambient (Note 7)	$R_{ hetaJA}$	450 300	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-40 to +125	°C

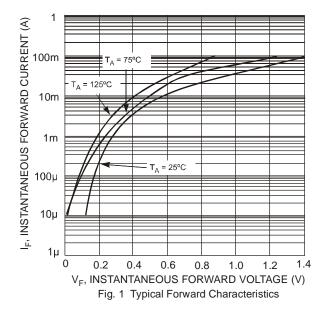
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

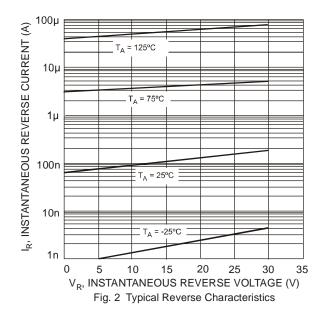
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	40		_	V	$I_{R} = 10\mu A$
Forward Voltage	V_{F}		290	370	mV	$I_F = 1mA$
Peak Reverse Current (Note 8)	I _R		_	0.5	μΑ	$V_R = 30V$
Total Capacitance	C _T	_	2	_	pF	$V_R = 1V, f = 1.0MHz$

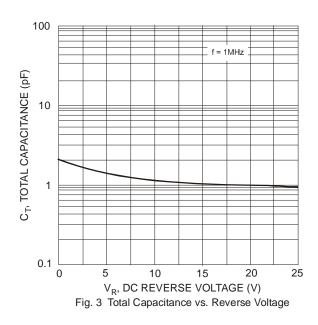
Notes:

- 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Part mounted on 1-inch sq. 2oz copper pad.8. Short duration pulse test used to minimize self-heating effect.









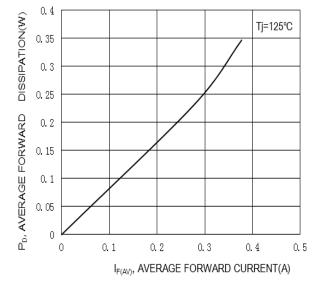


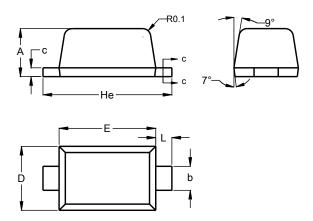
Fig 4. Forward Power Dissipation



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD523

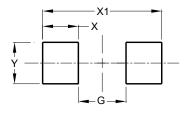


SOD523				
Dim	Min	Max		
Α	0.55	0.65		
b	0.26	0.34		
С	0.11	0.17		
D	0.75	0.85		
E 1.15 1.25				
He 1.55 1.65				
L	0.10	0.30		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD523



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
Υ	0.70



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